

Film Capacitors

EMI Suppression Capacitors (MKP)

Series/Type: B32922P/Q ... B32924P/Q

Date: October 2020

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X2 / 305 V AC

Typical applications

- X2 class for interference suppression
- "Across the line" application
- Severe ambient conditions
- Automotive application

Climatic

- Max. operating temperature: 125 °C
- Climatic category (IEC 60068-1): 40/125/56

Features

- Small dimensions
- Good self-healing properties
- AEC-Q200 compliant
- RoHS-compatible
- Halogen-free capacitors available on request

Construction

- Dielectric: polypropylene (MKP)
- Plastic case (UL 94 V-0)
- Epoxy resin sealing (UL 94 V-0)

Terminals

- Parallel wire leads, lead-free tinned
- Special lead lengths available on request

Marking

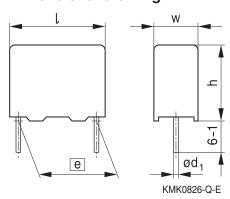
Manufacturer's logo, lot number, date code, rated capacitance (coded), capacitance tolerance (code letter), rated AC voltage (IEC), series number, sub-class (X2), dielectric code (MKP), climatic category, passive flammability category, approvals

Delivery mode

Bulk

Taped (Ammo pack or reel)
For taping details, refer to chapter
"Taping and packing".

Dimensional drawing



Dimensions in mm

Lead spacing	Lead diameter d ₁ ±0.05	Туре
15	0.8	B32922 P/Q
22.5	0.8	B32923 P/Q
27.5	0.8	B32924 P/Q



X2 / 305 V AC



Marking example



KMK2360-D

Approvals

Approval marks	Standards	Certificate
15	EN 60384-14:2014 IEC 60384-14:2013	ENEC-02931 (approved by UL)
c Al us	UL 60384-14:2014 CSA E60384-14:2013	E97863 (approved by UL)
CQC	GB/T6346.14-2015	CQC20001257420



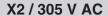


X2/305 V AC

Overview of available types

Lead spacing	15 mm	22.5 mm	27.5 mm
Туре	B32922 P/Q	B32923 P/Q	B32924 P/Q
$C_R (\mu F)$			
0.033			
0.039			
0.047			
0.056			
0.068			
0.082			
0.10			
0.12			
0.15			
0.18			
0.22			
0.27			
0.33			
0.39			
0.410			
0.47			
0.56			
0.68			
0.82			
1.0			
1.2			
1.5			
1.8			
2.0			
2.2			
2.7			
3.3			
3.9			
4.7			
5.6			







Ordering codes and packing units

Lead	C _R	Max. dimensions	Ordering code	Ammo	Reel	Untaped
spacing		$w \times h \times I$	(composition see	pack		
mm	μF	mm	below)	pcs./MOQ	pcs./MOQ	pcs./MOQ
15	0.033	$5.0\times10.5\times18.0$	B32922P3333+***	4680	5200	4000
	0.039	$5.0 \times 10.5 \times 18.0$	B32922P3393+***	4680	5200	4000
	0.047	$5.0 \times 10.5 \times 18.0$	B32922P3473+***	4680	5200	4000
	0.056	$5.0 \times 10.5 \times 18.0$	B32922P3563+***	4680	5200	4000
	0.068	$5.0 \times 10.5 \times 18.0$	B32922P3683+***	4680	5200	4000
	0.082	$5.0 \times 10.5 \times 18.0$	B32922P3823+***	4680	5200	4000
	0.10	$5.0 \times 10.5 \times 18.0$	B32922P3104+***	4680	5200	4000
	0.12	$6.0 \times 12.0 \times 18.0$	B32922P3124+***	3840	4400	4000
	0.15	$6.0 \times 12.0 \times 18.0$	B32922P3154+***	3840	4400	4000
	0.18	$7.0 \times 12.5 \times 18.0$	B32922P3184+***	3320	3600	4000
	0.22	$7.0 \times 12.5 \times 18.0$	B32922P3224+***	3320	3600	4000
	0.27	$8.0 \times 14.0 \times 18.0$	B32922P3274+***	2920	3000	2000
	0.33	$8.0 \times 14.0 \times 18.0$	B32922P3334M***	2920	3000	2000
	0.33	$8.5 \times 14.5 \times 18.0$	B32922Q3334+***	2720	2800	2000
	0.39	$9.0 \times 17.5 \times 18.0$	B32922P3394+***	2560	2800	2000
	0.56	$11.0 \times 18.5 \times 18.0$	B32922P3564+***	_	2200	1200
	0.68	$11.0\times18.5\times18.0$	B32922P3684M***	_	2200	1200

MOQ = Minimum Order Quantity, consisting of 4 packing units. Further intermediate capacitance values on request.

Composition of ordering code

+ = Capacitance tolerance code:

 $M = \pm 20\%$

 $K = \pm 10\%$

*** = Packaging code:

289 = Straight terminals, Ammo pack

189 = Straight terminals, Reel

003 = Straight terminals, untaped (lead length 3.2 ±0.3 mm)

000 = Straight terminals, untaped

(lead length 6.0 –1.0 mm)





X2/305 V AC

Ordering codes and packing units

Lead	C _R	Max. dimensions	Ordering code	Ammo	Reel	Untaped
spacing		$w \times h \times I$	(composition see	pack		
mm	μF	mm	below)	pcs./MOQ	pcs./MOQ	pcs./MOQ
22.5	0.22	$6.0 \times 15.0 \times 26.5$	B32923P3224+***	2720	2800	2880
	0.27	$6.0 \times 15.0 \times 26.5$	B32923P3274+***	2720	2800	2880
	0.33	$6.0 \times 15.0 \times 26.5$	B32923P3334M***	2720	2800	2880
	0.33	$7.0\times16.0\times26.5$	B32923Q3334+***	2320	2400	2520
	0.39	$7.0\times16.0\times26.5$	B32923P3394+***	2320	2400	2520
	0.41	$8.5 \times 16.5 \times 26.5$	B32923P3414+***	1920	2000	2040
	0.47	$8.5 \times 16.5 \times 26.5$	B32923P3474+***	1920	2000	2040
	0.56	$8.5 \times 16.5 \times 26.5$	B32923P3564M***	1920	2000	2040
	0.68	$10.5 \times 16.5 \times 26.5$	B32923P3684+***	1560	1600	2160
	0.82	$10.5 \times 18.5 \times 26.5$	B32923P3824+***	1560	1600	2160
	1.0	$11.0\times20.5\times26.5$	B32923P3105+***	1480	1400	2040
	1.2	$12.0 \times 22.0 \times 26.5$	B32923P3125+***	1320	1200	1800
	1.5	$14.5 \times 29.5 \times 26.5$	B32923P3155+***	_	_	1040
	1.8	$14.5 \times 29.5 \times 26.5$	B32923P3185+***	_	_	1040
	2.0	$14.5 \times 29.5 \times 26.5$	B32923P3205+***	_	_	1040
	2.2	$14.5\times29.5\times26.5$	B32923P3225+***	_	_	1040

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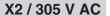
189 = Straight terminals, Reel

003 = Straight terminals, untaped (lead length 3.2 ±0.3 mm)

000 = Straight terminals, untaped

(lead length 6.0 - 1.0 mm)







Ordering codes and packing units

Lead	C_R	Max. dimensions	Ordering code	Ammo	Reel	Untaped
spacing		$w \times h \times I$	(composition see	pack		
mm	μF	mm	below)	pcs./MOQ	pcs./MOQ	pcs./MOQ
27.5	0.68	$11.0 \times 19.0 \times 31.5$	B32924P3684+***	_	1400	1280
	0.82	$11.0 \times 19.0 \times 31.5$	B32924P3824+***	_	1400	1280
	1.0	$11.0 \times 19.0 \times 31.5$	B32924P3105+***	_	1400	1280
	1.2	$11.0 \times 19.0 \times 31.5$	B32924P3125M***	_	1400	1280
	1.2	$12.5 \times 21.5 \times 31.5$	B32924Q3125+***	_	1200	1120
	1.5	$12.5 \times 21.5 \times 31.5$	B32924P3155+***	_	1200	1120
	1.8	$13.5 \times 23.0 \times 31.5$	B32924P3185+***	_	1000	1040
	2.2	$14.0 \times 24.5 \times 31.5$	B32924P3225M***	_	1000	1040
	2.7	$18.0 \times 27.5 \times 31.5$	B32924P3275+***	_	_	800
	3.3	$16.0 \times 32.0 \times 31.5$	B32924Q3335+***	_	_	880
	3.3	$18.0 \times 27.5 \times 31.5$	B32924P3335M***	_	_	800
	3.9	$18.0 \times 33.0 \times 31.5$	B32924P3395+***	_	_	800
	3.9	$21.0 \times 31.0 \times 31.5$	B32924Q3395+***	_	_	720
	4.7	$18.0 \times 33.0 \times 31.5$	B32924P3475M***	_	_	800
	4.7	$21.0 \times 31.0 \times 31.5$	B32924Q3475M***	_	_	720
-	5.6	$22.0\times36.5\times31.5$	B32924P3565+***	_	_	784

MOQ = Minimum Order Quantity, consisting of 4 packing units. Further intermediate capacitance values on request.

Composition of ordering code

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289 = Straight terminals, Ammo pack

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(lead length 3.2 ±0.3 mm)

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X2/305 V AC

Technical data and specifications

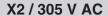
Reference standard: UL / IEC 60384-14:2013/AMD1:2016 and AEC-Q200D. All data given at T = 20 $^{\circ}$ C unless otherwise specified

Rated AC voltage (IEC 60384-14)	305 V (50/60 Hz)
Maximum continuous DC voltage V _{DC}	630 V
(≤ 85 °C)	
Max. operating temperature T _{op,max}	+125 °C
$(T_{op} = T_A + self-heating)$	
DC test voltage	Between terminals: 1312 V DC, 2 s

The repetition of this DC voltage test may damage the capacitor. Special care must be taken in case of use several capacitors in a parallel configuration.

case of use several capacitors in a parallel configuration.					
Dissipation factor tan δ (in 10 ⁻³)	at	$C \le 0.1 \ \mu F$	0.1 μF < C _R ≤2.2μ	$C_R > 2.2 \mu F$	
at 20 °C (upper limit values)	1 kHz	1.0	1.0	3.0	
	100 kHz	5.0	_	_	
Insulation resistance R_{ins} (in $G\Omega$)	$C_R \le 0.33 \mu$	ιF	$C_R > 0.33 \mu F$		
or time constant $\tau = C_R \cdot R_{ins}$ (in s)	15 GΩ		5000 s		
at 100 V DC, 20 °C, rel. humidity ≤ 65%					
and for 60 s (minimum as-delivered					
values)					
Passive flammability category	В				
Operating voltage V _{op} at high	$T_{op} \le 125$ °		$V_{op} = V_{AC}$ (continu	• /	
temperature	$T_{op} \le 125$ °	С	$V_{op} = 1.25 \cdot V_{AC} ($	1000 h)	
Biased humidity test 1	Temperatu	ire:	+40 °C ±2 °C		
	Relative hu	umidity (RH):	93% ±3%		
	Voltage va	lue:	305 V AC, 50 Hz		
	Test durati	on:	1000 hours		
Biased humidity test 2	Temperatu	ire:	+85 °C ±2 °C		
	Relative hu	umidity (RH):	85% ±2%		
	Voltage va	lue:	240 V AC, 50 Hz		
	Test durati	on:	500 hours		
Limit values after damp heat test	Capacitano	ce change l∆	C/Cl: ≤ 1)%	
	Dissipation	factor chan	ge l∆tan δl:	005	
	Insulation	resistance R _i	ns ≥ 2	00 MΩ	
Temperature cycling, 30 min maximum	-55 °C +125 °C / 100 cycles				
dwell time at each temperature extreme.					
1 min. maximum transition time.	No visible	damage			







Pulse handling capability

"dV/dt" represents the maximum permissible voltage change per unit of time for non-sinusoidal voltages, expressed in $V/\mu s$.

" k_0 " represents the maximum permissible pulse characteristic of the waveform applied to the capacitor, expressed in $V^2/\mu s$.

Note:

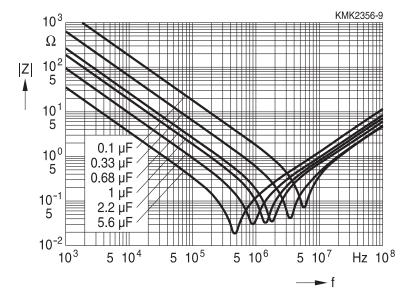
The values of dV/dt and k_0 provided below must not be exceeded in order to avoid damaging the capacitor.

dV/dt and k₀ values

Lead spacing (mm)	15	22.5	27.5
dV/dt (V/μs)	340	170	80
$k_0 (V^2/\mu s)$	292 400	146 200	69 000

Impedance Z versus frequency f

(typical values)



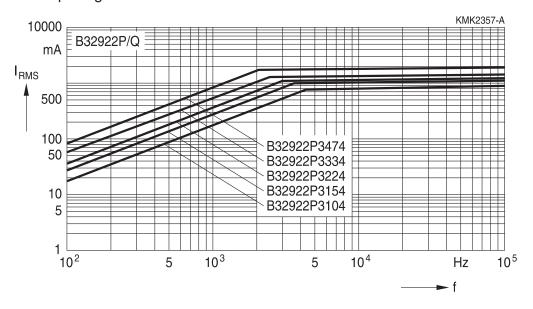




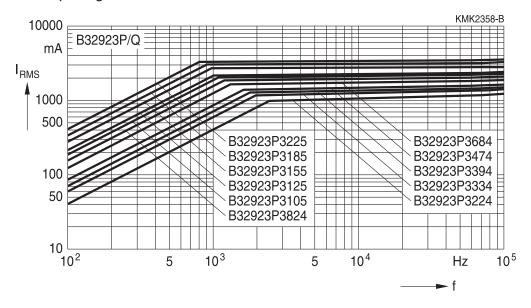
X2/305 V AC

Permissible AC current I_{RMS} versus frequency f (for sinusoidal waveforms $T_A \le 90$ °C and $\triangle ESR < 100\%$ from receipt condition)

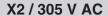
Lead spacing 15 mm



Lead spacing 22.5 mm



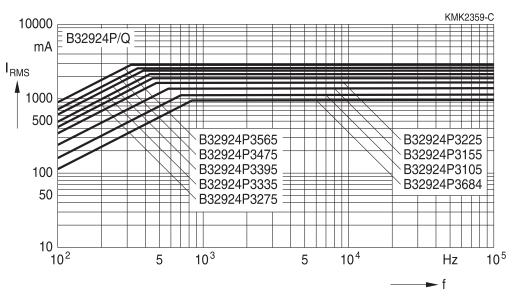






Permissible AC current I_{RMS} versus frequency f (for sinusoidal waveforms $T_A \le 90$ °C and $\triangle ESR < 100\%$ from receipt condition)

Lead spacing 27.5 mm



Testing and Standards

Test	Reference	Conditions of test		Performance requirements
Electrical	IEC 60384-14	Voltage Proof:		Within specified limits
parameters		Between terminals:		
		$4.3 \times V_R$ (DC), 1min	l	
		Terminals and encl	osure:	
		2 V _R + 1500 V AC,	1 min	
		Insulation resistanc	e, R _{ins}	
		Capacitance, C		
		Dissipation factor, to	an δ	
Robustness	IEC 60068-2-21	Tensile strength (te	st Ua1)	Capacitance and $tan \delta$
of termina-		Wire diameter	Tensile	within specified limits
tions			force	
		$0.5 < d_1 \le 0.8 \text{ mm}$	10 N	
		$0.8 < d_1 \le 1.25 \text{ mm}$	20 N	
Resistance	IEC 60068-2-20,	Solder bath tempera	ature at	$\Delta C/C_0 \le 5\%$
to soldering	test Tb,	260 ±5 °C, immersion	on for	tan δ within specified limits
heat	method 1A	10 seconds		
Rapid	IEC 60384-14	T _A = lower category temperature		No visible damage
change of		T _B = upper category	temperature	$ \Delta C/C_0 \le 5\%$
temperature		Five cycles, duratio	n t = 30 min	tan δ within specified limits





X2 / 305 V AC

Test	Reference	Conditions of test	Performance requirements
Vibration	IEC 60384-14	Test F _C : vibration sinusoidal Displacement: 0.75 mm Accleration: 98 m/s ² Frequency: 10 Hz 500 Hz Test duration: 3 orthogonal axes, 2 hours each axe	No visible damage
Bump	IEC 60384-14	Test Eb: Total 4000 bumps with 400 m/s² mounted on PCB 6 ms duration	No visible damage $ \Delta C/C_0 \leq 5\%$ tan δ within specified limits
Damp heat, steady state	IEC 60384-14	Test Ca 40 °C / 93% RH / 56 days	No visible damage $\begin{split} \Delta C/C_0 &\leq 5\% \\ \Delta \ tan \ \delta &\leq 0.008 \ for \ C \leq 1 \ \mu F \\ \Delta \ tan \ \delta &\leq 0.005 \ for \ C > 1 \ \mu F \\ Voltage \ proof \\ R_{ins} &\geq 50\% \ of \ initial \ limit \end{split}$
Impulse test Endurance	IEC 60384-14	3 impulses $T_{\rm B}$ / 1.25 $V_{\rm R}$ / 1000 hours, 1000 $V_{\rm RMS}$ for 0.1 s every hour	No visible damage $\begin{split} \Delta C/C_0 &\leq 10\% \\ \Delta \ tan \ \delta &\leq 0.008 \ for \ C \leq 1 \ \mu F \\ \Delta \ tan \ \delta &\leq 0.005 \ for \ C > 1 \ \mu F \\ Voltage \ proof \\ R_{ins} &\geq 50\% \ of \ initial \ limit \end{split}$
Charge and discharge	IEC 60384-14	dv/dt = 100 V/μs Cycles = 10 000	$\begin{split} \Delta C/C_0 &\leq 10\% \\ \Delta \tan \delta &\leq 0.008 \text{ for } C \leq 1 \mu\text{F} \\ \Delta \tan \delta &\leq 0.005 \text{ for } C > 1 \mu\text{F} \\ \text{Voltage proof} \\ R_{\text{ins}} &\geq 50\% \text{ of initial limit} \end{split}$
Passive flammability	IEC 60384-14	Flame applied for a period of time depending on capacitor volume	В
Active flammability	IEC 60384-14	20 discharges at 2.5 kV + V _R	The cheesecloth shall not burn with a flame
Biased humidity 1		85 °C / 85% relative humidity / 500 h / 240V AC, 50Hz	No visible damage $ \Delta C/C_0 \leq 10\%$ Dissipation factor change $ \Delta \tan \delta \leq 0.005$ Insulation resistance $R_{\text{ins}} \geq 200 \text{ M}\Omega$
High temperature exposure (storage)	AEC-Q200	125 °C for 1000 hrs	No visible damage $ \Delta C/C_0 \leq 10\%$ $ \Delta \tan \delta \leq 0.008$ $R_{ins} \geq 50\% \text{ of initial limit}$





X2 / 305 V AC

Test	Reference	Conditions of test	Performance requirements
Tempera-	AEC-Q200	T _A = -55 °C	No visible damage
ture		T _B =upper category temperature	$ \Delta C/C_0 \le 5\%$
cycling		1000 cycles, duration t = 30 min	
Biased	AEC-Q200	40 °C / 93% relative humidity /	No visible damage
humidity 2		1000 h / 305V AC, 50Hz	$ \Delta C/C_0 \leq 10\%$
			$ \Delta \tan \delta \le 0.005$
			Insulation resistance
			$R_{ins} \ge 200 M\Omega$
Operating	AEC-Q200	Rated voltage / 125 °C / 1000 h	No visible damage
life		-	$ \Delta C/C_0 \leq 10\%$
			$ \Delta \tan \delta \le 0.008$
			R _{ins} ≥ 50% of initial limit
Physical	AEC-Q200	As per user and supplier	No visible damage
dimension	7.20 0.200	specification (length, width,	Within specification
		height, lead length, lead space)	'
Resistance	AEC-Q200	260 ± 5 °C for 10 s	No visible damage
to soldering	7.20 0.200		$ \Delta C/C_0 \le 5\%$
heat			$ \Delta \tan \delta \leq 0.001$
Solderability	AFC-0200	J-STD-002,	A minimum of 95% of each of
	7120 0200	For both leaded and SMD	the surface being tested shall
		Electrical test not required	be exhibit good wetting. The
		Magnification 50 ×	balance of the surface may
		Conditions: leaded; method A at	contain only small pin holes,
		235 °C, category 3	dewetted areas, and rough
			spots provided such defects
			are not concentrated in one
			area. There shall be no
			nonwetting or exposed base
			metal within the evaluated
			area.
Moisture	AEC-Q200	MIL-STD-202 Method 106,	No visible damage
resistance	, 0	t = 24 h/cycle	$ \Delta C/C_0 \le 5\%$
10010101100			$ \Delta \tan \delta \le 0.005$
		Note:	$R_{ins} \ge 50\%$ of initial limit
		Steps 7a and 7b not required	1115
		Unpowered	
		Measurement at 24 ±4 h after	
Electrical.		test conclusion	No visible down
Electrical	AEC-Q200	Temp A: -40 °C,	No visible damage
characteri-		Temp B: +125 °C,	Summary to show Min, Max,
zation		Temp C: +25 °C	Mean and Standard deviation
			at room as well as min. and
			max. operating temperatures





X2/305 V AC

Test	Reference	Conditions of test	Performance requirements
Terminal	AEC-Q200	MIL-STD-202 Method 211,	No visible damage
strength		Test leaded device lead integrity	$ \Delta C/C_0 \le 2\%$
(leaded)		only	$ \Delta \tan \delta \le 0.0015$
		Conditions: A (2.27 kg), C (227 g)	$R_{ins} \ge 50\%$ of initial limit
Resistance	AEC-Q200	MIL-STD-202 Method 215,	No visible damage
to solvent		Notes:	$ \Delta C/C_0 \le 2\%$
		Also aqueous wash chemical -	$ \Delta \tan \delta \le 0.0015$
		Okemclean or equivalent	$R_{ins} \ge 50\%$ of initial limit
		Do not use banned solvents	
Mechanical	AEC-Q200	MIL-STD-202 method 213,	No visible damage
shock		Figure 1 of method 213	$ \Delta C/C_0 \le 3\%$
		Condition C	$ \Delta \tan \delta \le 0.004$
			$R_{\text{ins}} \geq 50\%$ of initial limit
Vibration	AEC-Q200	5 g's for 20 min,	No visible damage
		12 cycles each of 3 orientations	
		Use 8" × 5" PCB, .031" thick.	
		7 secure points on one 8" side	
		and 2 secure points at corners of	
		opposite sides	
		Parts mounted within 2" from any	
		secure point.	
		Test from 10-2000 Hz	

Mounting guidelines

1 Soldering

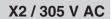
1.1 Solderability of leads

The solderability of terminal leads is tested to IEC 60068-2-20, test Ta, method 1.

Before a solderability test is carried out, terminals are subjected to accelerated ageing (to IEC 60068-2-2, test Ba: 4 h exposure to dry heat at 155 °C). Since the ageing temperature is far higher than the upper category temperature of the capacitors, the terminal wires should be cut off from the capacitor before the ageing procedure to prevent the solderability being impaired by the products of any capacitor decomposition that might occur.

Solder bath temperature	235 ±5 °C
Soldering time	2.0 ±0.5 s
Immersion depth	2.0 +0/-0.5 mm from capacitor body or seating plane
Evaluation criteria:	
Visual inspection	Wetting of wire surface by new solder ≥90%, free-flowing solder



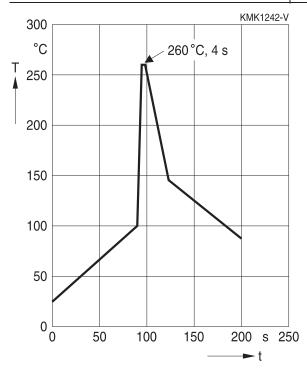




1.2 Resistance to soldering heat

Resistance to soldering heat is tested to IEC 60068-2-20, test Tb, method 1. Conditions:

Serie	s	Solder bath temperature	Soldering time
MKT	boxed (except $2.5 \times 6.5 \times 7.2$ mm) coated uncoated (lead spacing >10 mm)	260 ±5 °C	10 ±1 s
MFP			
MKP	(lead spacing >7.5 mm)		
MKT	boxed (case $2.5 \times 6.5 \times 7.2$ mm)		5 ±1 s
MKP	(lead spacing ≤7.5 mm)		<4 s
MKT	uncoated (lead spacing ≤10 mm) insulated (B32559)		recommended soldering profile for MKT uncoated (lead spacing ≤ 10 mm) and insulated (B32559)



Immersion depth	2.0 +0/-0.5 mm from capacitor body or seating plane	
Shield	Heat-absorbing board, (1.5 ±0.5) mm thick, between	
	capacitor body and liquid solder	
Evaluation criteria:		
Visual inspection	No visible damage	
$\Delta C/C_0$	2% for MKT/MKP/MFP	
$\Delta C/C_0$	5% for EMI suppression capacitors	
$tan \ \delta$	As specified in sectional specification	





X2 / 305 V AC

1.3 General notes on soldering

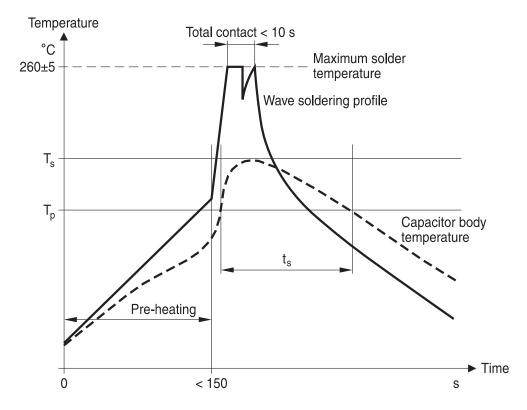
Permissible heat exposure loads on film capacitors are primarily characterized by the upper category temperature T_{max} . Long exposure to temperatures above this type-related temperature limit can lead to changes in the plastic dielectric and thus change irreversibly a capacitor's electrical characteristics. For short exposures (as in practical soldering processes) the heat load (and thus the possible effects on a capacitor) will also depend on other factors like:

- Pre-heating temperature and time
- Forced cooling immediately after soldering
- Terminal characteristics: diameter, length, thermal resistance, special configurations (e.g. crimping)
- Height of capacitor above solder bath
- Shadowing by neighboring components
- Additional heating due to heat dissipation by neighboring components
- Use of solder-resist coatings

The overheating associated with some of these factors can usually be reduced by suitable countermeasures. For example, if a pre-heating step cannot be avoided, an additional or reinforced cooling process may possibly have to be included.

Recommendations

As a reference, the recommended wave soldering profile for our film capacitors is as follows:

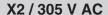


T_s: Capacitor body maximum temperature at wave soldering

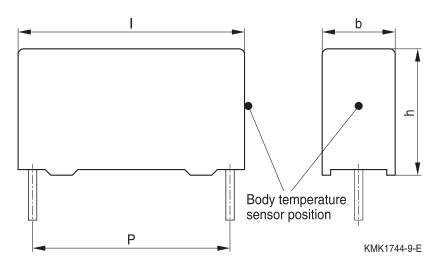
 T_p : Capacitor body maximum temperature at pre-heating

KMK1745-A-E









Body temperature should follow the description below:

MKP capacitor

During pre-heating: $T_p \le 110 \, ^{\circ}\text{C}$ During soldering: $T_s \le 120 \, ^{\circ}\text{C}$, $t_s \le 45 \, \text{s}$

MKT capacitor

During pre-heating: $T_p \le 125$ °C During soldering: $T_s \le 160$ °C, $t_s \le 45$ s

When SMD components are used together with leaded ones, the film capacitors should not pass into the SMD adhesive curing oven. The leaded components should be assembled after the SMD curing step.

Leaded film capacitors are not suitable for reflow soldering.

In order to ensure proper conditions for manual or selective soldering, the body temperature of the capacitor (T_s) must be ≤ 120 °C.

One recommended condition for manual soldering is that the tip of the soldering iron should be <360 °C and the soldering contact time should be no longer than 3 seconds.

For uncoated MKT capacitors with lead spacings ≤10 mm (B32560/B32561) the following measures are recommended:

- pre-heating to not more than 110 °C in the preheater phase
- rapid cooling after soldering

Please refer to our Film Capacitors Data Book in case more details are needed.





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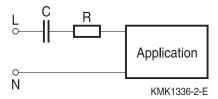
Application note for the different possible X1 / X2 positions

In series with the powerline (i.e. capacitive power supply)

Typical Applications:

- Power meters
- ECUs for white goods and household appliances
- Different sensor applications
- Severe ambient conditions

Basic circuit



Required features

- High capacitance stability over the lifetime
- Narrow tolerances for a controlled current supply

Recommended product series

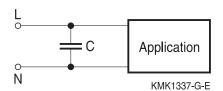
- B3293* (305 V AC) heavy duty with EN approval for X2 (UL Q1/2010)
- B3265* MKP series standard MKP capacitor without safety approvals
- B3267*L MKP series standard MKP capacitor without safety approvals
- B3292*H/J (305 V AC), severe ambient condition, approved as X2

In parallel with the powerline

Typical Applications:

Standard X2 are used parallel over the mains for reducing electromagnetic interferences coming from the grid. For such purposes they must meet the applicable EMC directives and standards.

Basic circuit



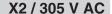
Required features

- Standard safety approvals (ENEC, UL, CSA, CQC)
- High pulse load capability
- Withstand surge voltages

Recommended product series

- B3292*C/D (305 V AC) standard series, approved as X2
- B3291* (330 V AC), approved as X1
- B3291* (530 V AC), approved as X1
- B3291* (550 V AC), approved as X1
- B3292*H/J (305 V AC), severe ambient condition, approved as X2







Cautions and warnings

- Do not exceed the upper category temperature (UCT).
- Do not apply any mechanical stress to the capacitor terminals.
- Avoid any compressive, tensile or flexural stress.
- Do not move the capacitor after it has been soldered to the PC board.
- Do not pick up the PC board by the soldered capacitor.
- Do not place the capacitor on a PC board whose PTH hole spacing differs from the specified lead spacing.
- Do not exceed the specified time or temperature limits during soldering.
- Avoid external energy inputs, such as fire or electricity.
- Avoid overload of the capacitors.
- Consult us if application is with severe temperature and humidity condition.
- There are no serviceable or repairable parts inside the capacitor. Opening the capacitor or any attempts to open or repair the capacitor will void the warranty and liability of TDK Electronics.
- Please note that the standards referred to in this publication may have been revised in the meantime.

The table below summarizes the safety instructions that must always be observed. A detailed description can be found in the relevant sections of the chapters "General technical information" and "Mounting guidelines".

Topic	Safety information	Reference chapter "General technical information"
Storage	Make sure that capacitors are stored within the	4.5
conditions	specified range of time, temperature and humidity conditions.	"Storage conditions"
Flammability	Avoid external energy, such as fire or electricity (passive flammability), avoid overload of the capacitors (active flammability) and consider the flammability of materials.	5.3 "Flammability"
Resistance to vibration	Do not exceed the tested ability to withstand vibration. The capacitors are tested to IEC 60068-2-6:2007. TDK Electronics offers film capacitors specially designed for operation under more severe vibration regimes such as those found in automotive applications. Consult our catalog "Film Capacitors for Automotive Electronics".	5.2 "Resistance to vibration"





X2 / 305 V AC

Topic	Safety information	Reference chapter "Mounting guidelines"
Soldering	Do not exceed the specified time or temperature limits during soldering.	1 "Soldering"
Cleaning	Use only suitable solvents for cleaning capacitors.	2 "Cleaning"
Embedding of capacitors in finished assemblies	When embedding finished circuit assemblies in plastic resins, chemical and thermal influences must be taken into account. Caution: Consult us first, if you also wish to embed other uncoated component types!	3 "Embedding of capacitors in finished assemblies"

Design of our capacitors

Our EMI capacitors use polypropylene (PP) film metalized with a thin layer of Zinc (Zn). The following key points have made this design suitable to IEC/UL testing, holding a minimum size.

- Overvoltage AC capability with very high temperature Endurance test of IEC 60384-14:2013 (4th edition) / UL 60384-14:2014 (2nd edition) must be performed at $1.25 \times V_R$ at maximum temperature, during 1000 hours, with a capacitance drift less than 10%.
- Higher breakdown voltage withstanding if compared to other film metallizations, like Aluminum. IEC 60384-14:2013 (4th edition) / UL 60384-14:2014 (2nd edition) establishes high voltage tests performed at $4.3 \times V_R 1$ minute, impulse testing at 2500 V for C = 1 µF and active flammability tests.
- Damp heat steady state: 40 °C/ 93% RH / 56 days. (without voltage or current load)

Effect of humidity on capacitance stability

Long contact of a film capacitor with humidity can produce irreversible effects. Direct contact with liquid water or excess exposure to high ambient humidity or dew will eventually remove the film metallization and thus destroy the capacitor. Plastic boxed capacitors must be properly tested in the final application at the worst expected conditions of temperature and humidity in order to check if any parameter drift may provoke a circuit malfunction.

In case of penetration of humidity through the film, the layer of Zinc can be degraded, specially under AC operation (change of polarity), accelerated by the temperature, provoking an increment of the serial resistance of the electrode and eventually a reduction of the capacitance value. For DC operation, the parameter drift is much less.

Plastic boxes and resins can not protect 100% against humidity. Metal enclosures, resin potting or coatings or similar measures by customers in their applications will offer additional protection against humidity penetration.



X2 / 305 V AC



Display of ordering codes for TDK Electronics products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications, on the company website, or in order-related documents such as shipping notes, order confirmations and product labels. The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products.

Detailed information can be found on the Internet under www.tdk-electronics.tdk.com/orderingcodes.



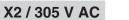


X2/305 V AC

Symbols and terms

Symbol	English	German
α	Heat transfer coefficient	Wärmeübergangszahl
α_{C}	Temperature coefficient of capacitance	Temperaturkoeffizient der Kapazität
Α	Capacitor surface area	Kondensatoroberfläche
β_{C}	Humidity coefficient of capacitance	Feuchtekoeffizient der Kapazität
С	Capacitance	Kapazität
C_R	Rated capacitance	Nennkapazität
ΔC	Absolute capacitance change	Absolute Kapazitätsänderung
ΔC/C	Relative capacitance change (relative deviation of actual value)	Relative Kapazitätsänderung (relative Abweichung vom Ist-Wert)
$\Delta C/C_R$	Capacitance tolerance (relative deviation	Kapazitätstoleranz (relative Abweichung
	from rated capacitance)	vom Nennwert)
dt	Time differential	Differentielle Zeit
Δt	Time interval	Zeitintervall
ΔΤ	Absolute temperature change (self-heating)	Absolute Temperaturänderung (Selbsterwärmung)
$\Delta tan \delta$	Absolute change of dissipation factor	Absolute Änderung des Verlustfaktors
ΔV	Absolute voltage change	Absolute Spannungsänderung
dV/dt	Time differential of voltage function (rate of voltage rise)	Differentielle Spannungsänderung (Spannungsflankensteilheit)
$\Delta V/\Delta t$	Voltage change per time interval	Spannungsänderung pro Zeitintervall
E	Activation energy for diffusion	Aktivierungsenergie zur Diffusion
ESL	Self-inductance	Eigeninduktivität
ESR	Equivalent series resistance	Ersatz-Serienwiderstand
f	Frequency	Frequenz
f ₁	Frequency limit for reducing permissible AC voltage due to thermal limits	Grenzfrequenz für thermisch bedingte Reduzierung der zulässigen Wechselspannung
f_2	Frequency limit for reducing permissible AC voltage due to current limit	Grenzfrequenz für strombedingte Reduzierung der zulässigen Wechselspannung
f _r	Resonant frequency	Resonanzfrequenz
F_D	Thermal acceleration factor for diffusion	Therm. Beschleunigungsfaktor zur Diffusion
F_T	Derating factor	Deratingfaktor
i	Current (peak)	Stromspitze
Ic	Category current (max. continuous current)	Kategoriestrom (max. Dauerstrom)







Symbol	English	German
I _{RMS}	(Sinusoidal) alternating current,	(Sinusförmiger) Wechselstrom
	root-mean-square value	
i_z	Capacitance drift	Inkonstanz der Kapazität
k_0	Pulse characteristic	Impulskennwert
Ls	Series inductance	Serieninduktivität
λ	Failure rate	Ausfallrate
λ_{o}	Constant failure rate during useful	Konstante Ausfallrate in der
	service life	Nutzungsphase
λ_{test}	Failure rate, determined by tests	Experimentell ermittelte Ausfallrate
P_{diss}	Dissipated power	Abgegebene Verlustleistung
P_{gen}	Generated power	Erzeugte Verlustleistung
Q	Heat energy	Wärmeenergie
ρ	Density of water vapor in air	Dichte von Wasserdampf in Luft
R	Universal molar constant for gases	Allg. Molarkonstante für Gas
R	Ohmic resistance of discharge circuit	Ohmscher Widerstand des
		Entladekreises
R_{i}	Internal resistance	Innenwiderstand
R_{ins}	Insulation resistance	Isolationswiderstand
R_P	Parallel resistance	Parallelwiderstand
R_s	Series resistance	Serienwiderstand
S	severity (humidity test)	Schärfegrad (Feuchtetest)
t	Time	Zeit
Т	Temperature	Temperatur
τ	Time constant	Zeitkonstante
tan δ	Dissipation factor	Verlustfaktor
tan $\delta_{\scriptscriptstyle D}$	Dielectric component of dissipation factor	Dielektrischer Anteil des Verlustfaktors
tan δ_{P}	Parallel component of dissipation factor	Parallelanteil des Verlfustfaktors
tan δ_{S}	Series component of dissipation factor	Serienanteil des Verlustfaktors
T _A	Temperature of the air surrounding the component	Temperatur der Luft, die das Bauteil umgibt
T_{max}	Upper category temperature	Obere Kategorietemperatur
T _{min}	Lower category temperature	Untere Kategorietemperatur
t _{OL}	Operating life at operating temperature	Betriebszeit bei Betriebstemperatur und
•	and voltage	-spannung
T_op	Operating temperature, $T_A + \Delta T$	Beriebstemperatur, $T_A + \Delta T$
T _R	Rated temperature	Nenntemperatur
T_{ref}	Reference temperature	Referenztemperatur
t_{SL}	Reference service life	Referenz-Lebensdauer





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Symbol	English	German
V_{AC}	AC voltage	Wechselspannung
V_{C}	Category voltage	Kategoriespannung
$V_{C,RMS}$	Category AC voltage	(Sinusförmige)
		Kategorie-Wechselspannung
V_{CD}	Corona-discharge onset voltage	Teilentlade-Einsatzspannung
V_{ch}	Charging voltage	Ladespannung
V_{DC}	DC voltage	Gleichspannung
$V_{\sf FB}$	Fly-back capacitor voltage	Spannung (Flyback)
V_{i}	Input voltage	Eingangsspannung
V_{\circ}	Output voltage	Ausgangssspannung
V_{op}	Operating voltage	Betriebsspannung
V_p	Peak pulse voltage	Impuls-Spitzenspannung
V_{pp}	Peak-to-peak voltage Impedance	Spannungshub
V_R	Rated voltage	Nennspannung
$\hat{\mathbf{v}}_{R}$	Amplitude of rated AC voltage	Amplitude der Nenn-Wechselspannung
V_{RMS}	(Sinusoidal) alternating voltage,	(Sinusförmige) Wechselspannung
	root-mean-square value	
V_{SC}	S-correction voltage	Spannung bei Anwendung "S-correction"
V_{sn}	Snubber capacitor voltage	Spannung bei Anwendung
		"Beschaltung"
Z	Impedance	Scheinwiderstand
е	Lead spacing	Rastermaß



Important notes

The following applies to all products named in this publication:

- 1. Some parts of this publication contain statements about the suitability of our products for certain areas of application. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application. As a rule, we are either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether a product with the properties described in the product specification is suitable for use in a particular customer application.
- 2. We also point out that in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified. In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or lifesaving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.
- 3. The warnings, cautions and product-specific notes must be observed.
- 4. In order to satisfy certain technical requirements, some of the products described in this publication may contain substances subject to restrictions in certain jurisdictions (e.g. because they are classed as hazardous). Useful information on this will be found in our Material Data Sheets on the Internet (www.tdk-electronics.tdk.com/material). Should you have any more detailed questions, please contact our sales offices.
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- 6. Unless otherwise agreed in individual contracts, all orders are subject to our General Terms and Conditions of Supply.



Important notes

- 7. Our manufacturing sites serving the automotive business apply the IATF 16949 standard. The IATF certifications confirm our compliance with requirements regarding the quality management system in the automotive industry. Referring to customer requirements and customer specific requirements ("CSR") TDK always has and will continue to have the policy of respecting individual agreements. Even if IATF 16949 may appear to support the acceptance of unilateral requirements, we hereby like to emphasize that only requirements mutually agreed upon can and will be implemented in our Quality Management System. For clarification purposes we like to point out that obligations from IATF 16949 shall only become legally binding if individually agreed upon.
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